

# 3SK234

Silicon N Channel Dual Gate MOS FET  
VHF TV Tuner RF Amplifier

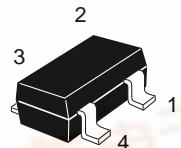
## Features

- Low voltage operation.
- Superior cross modulation characteristics.

**Table 1 Absolute Maximum Ratings**  
(Ta = 25°C)

Item	Symbol	Rating	Unit
Drain to source voltage	V <sub>DS</sub>	12	V
Gate 1 to source voltage	V <sub>G1S</sub>	±10	V
Gate 2 to source voltage	V <sub>G2S</sub>	±10	V
Drain current	I <sub>D</sub>	35	mA
Channel power dissipation	P <sub>ch</sub>	150	mW
Channel temperature	T <sub>ch</sub>	125	°C
Storage temperature	T <sub>stg</sub>	-55 to +125	°C

MPAK-4



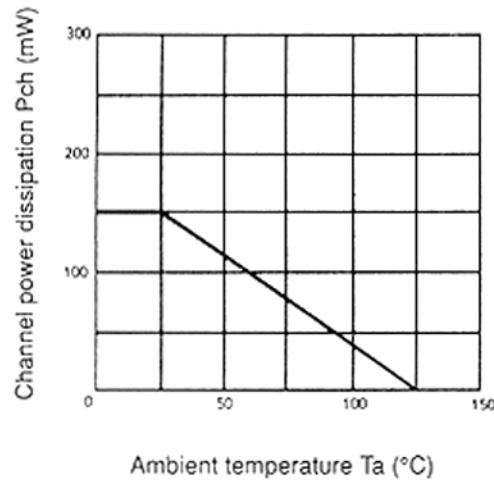
1. Source
2. Gate 1
3. Gate 2
4. Drain

**3SK234****Table 2 Electrical Characteristics (Ta = 25°C)**

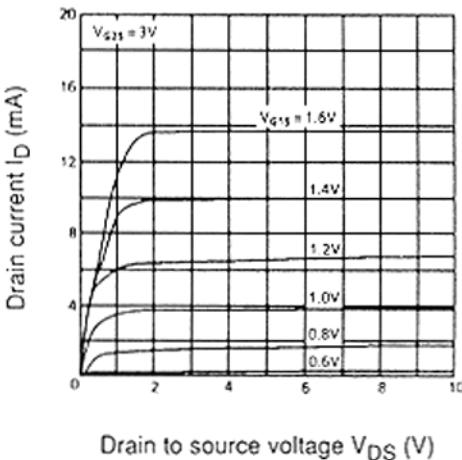
Item	Symbol	Min	Typ	Max	Unit	Test condition
Drain to source breakdown voltage	V <sub>(BR)DSX</sub>	12	—	—	V	I <sub>D</sub> = 200 µA, V <sub>G1S</sub> = -5 V, V <sub>G2S</sub> = -5 V
Gate 1 to source breakdown voltage	V <sub>(BR)G1SS</sub>	±10	—	—	V	I <sub>G1</sub> = ±10 µA, V <sub>G2S</sub> = V <sub>DS</sub> = 0
Gate 2 to source breakdown voltage	V <sub>(BR)G2SS</sub>	±10	—	—	V	I <sub>G2</sub> = ±10 µA, V <sub>G1S</sub> = V <sub>DS</sub> = 0
Gate 1 cutoff current	I <sub>G1SS</sub>	—	—	±100	nA	V <sub>G1S</sub> = ±8 V, V <sub>G2S</sub> = V <sub>DS</sub> = 0
Gate 2 cutoff current	I <sub>G2SS</sub>	—	—	±100	nA	V <sub>G2S</sub> = ±8 V, V <sub>G1S</sub> = V <sub>DS</sub> = 0
Drain current	I <sub>DSS</sub>	0	—	1	mA	V <sub>DS</sub> = 4 V, V <sub>G1S</sub> = 0, V <sub>G2S</sub> = 3 V
Gate 1 to source cutoff voltage	V <sub>G1S(off)</sub>	0	—	+1.0	V	V <sub>DS</sub> = 6 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 100 µA
Gate 2 to source cutoff voltage	V <sub>G2S(off)</sub>	0	—	+1.0	V	V <sub>DS</sub> = 6 V, V <sub>G1S</sub> = 3 V, I <sub>D</sub> = 100 µA
Forward transfer admittance	y <sub>fs</sub>	13	17	—	mS	V <sub>DS</sub> = 6 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 10 mA, f = 1 kHz
Input capacitance	C <sub>iss</sub>	2.5	3.5	4.5	pF	V <sub>DS</sub> = 6 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 10 mA, f = 1 MHz
Output capacitance	C <sub>oss</sub>	1.0	1.4	1.8	pF	
Reverse transfer capacitance	C <sub>rss</sub>	—	0.018	0.03	pF	
Power gain	PG	22	27.6	—	dB	V <sub>DS</sub> = 4 V, V <sub>G2S</sub> = 3 V, I <sub>D</sub> = 10 mA, f = 200 MHz
Noise figure	NF	—	1.77	2.7	dB	



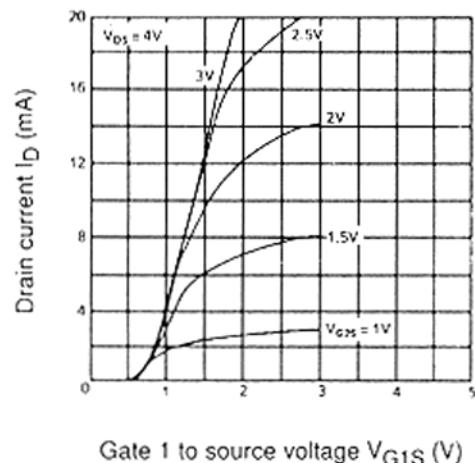
Maximum channel power dissipation curve



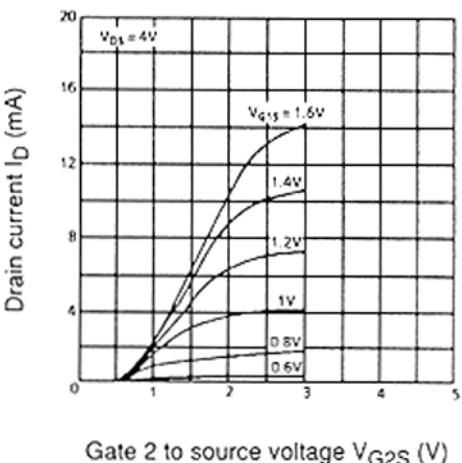
Typical output characteristics

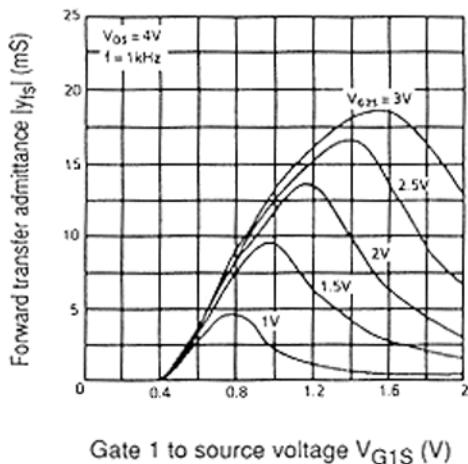


Drain current vs. gate 1 to source voltage

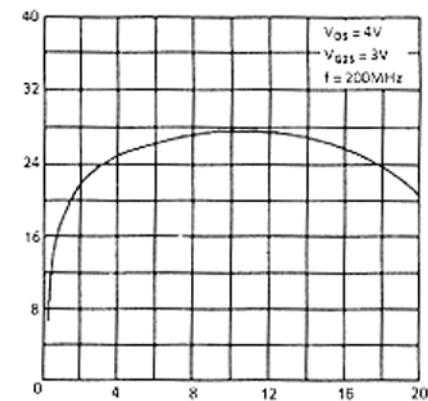


Drain current vs. gate 2 to source voltage

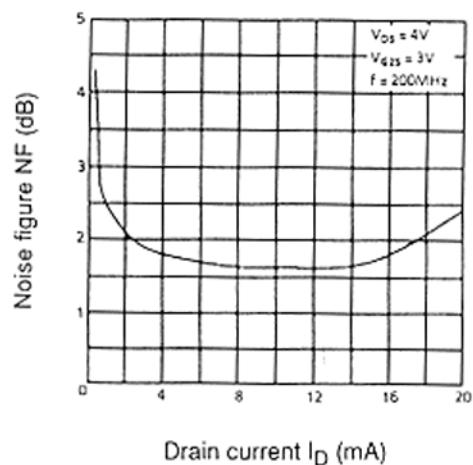


**3SK234**Forward transfer admittance  
vs. gate 1 to source voltageGate 1 to source voltage  $V_{G1S}$  (V)

Power gain vs. drain current

Drain current  $I_D$  (mA)

Noise figure vs. drain current

Drain current  $I_D$  (mA)